



# Micro-Power, Zero-Drift, Rail-to-Rail Out Instrumentation Amplifier

Check for Samples: [INA333-HT](#)

## FEATURES

- **Low Offset Voltage:** 25  $\mu\text{V}$  (max at 25°C),  $G \geq 100$
- **Low Drift:** 0.2  $\mu\text{V}/^\circ\text{C}$ ,  $G \geq 1000$
- **Low Noise:** 55  $\text{nV}/\sqrt{\text{Hz}}$ ,  $G \geq 100$
- **High CMRR:** 100 dB (min at 25°C),  $G \geq 10$
- **Supply Range:** +1.8 V to +5.5 V
- **Input Voltage:** (V–) +0.1 V to (V+) –0.1 V
- **Output Range:** (V–) +0.05 V to (V+) –0.05V
- **Low Quiescent Current:** 198  $\mu\text{A}$
- **RFI Filtered Inputs**

## APPLICATIONS

- **Down-Hole Drilling**
- **High Temperature Environments**

## DESCRIPTION

The INA333 is a low-power, precision instrumentation amplifier offering excellent accuracy. The versatile 3-op amp design, small size, and low power make it ideal for a wide range of portable applications.

A single external resistor sets any gain from 1 to 1000. The INA333 is designed to use an industry-standard gain equation:  $G = 1 + (100\text{k}\Omega/R_G)$ .

The INA333 provides very low offset voltage (25  $\mu\text{V}$  at 25°C,  $G \geq 100$ ), excellent offset voltage drift (0.2  $\mu\text{V}/^\circ\text{C}$ ,  $G \geq 100$ ), and high common-mode rejection (100 dB at 25°C,  $G \geq 10$ ). It operates with power supplies as low as 1.8 V ( $\pm 0.9\text{V}$ ), and quiescent current is only 50  $\mu\text{A}$ —ideal for battery-operated systems. Using autocalibration techniques to ensure excellent precision over the extended industrial temperature range, the INA333 also offers exceptionally low noise density (55  $\text{nV}/\sqrt{\text{Hz}}$ ) that extends down to dc.

The INA333 is specified over the  $T_A = -55^\circ\text{C}$  to  $+210^\circ\text{C}$  temperature range.

## SUPPORTS EXTREME TEMPERATURE APPLICATIONS

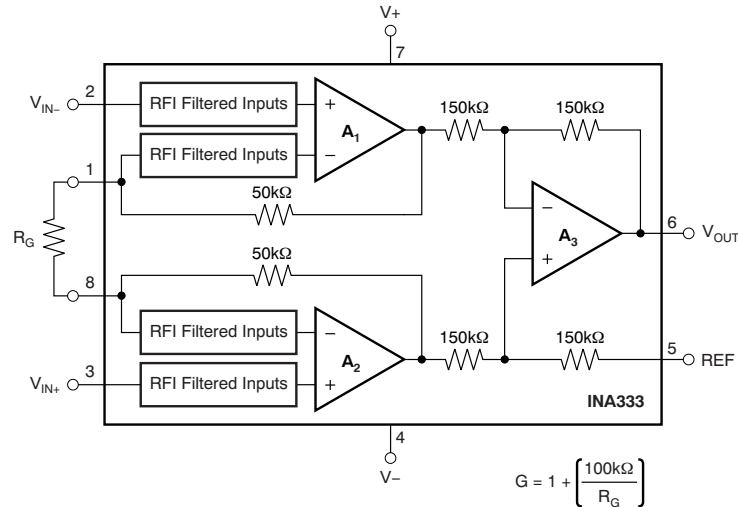
- **Controlled Baseline**
- **One Assembly/Test Site**
- **One Fabrication Site**
- **Available in Extreme ( $-55^\circ\text{C}/210^\circ\text{C}$ ) Temperature Range<sup>(1)</sup>**
- **Extended Product Life Cycle**
- **Extended Product-Change Notification**
- **Product Traceability**
- **Texas Instruments' high temperature products utilize highly optimized silicon (die) solutions with design and process enhancements to maximize performance over extended temperatures.**

(1) Custom temperature ranges available



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This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

### ORDERING INFORMATION<sup>(1)</sup>

T <sub>A</sub>	PACKAGE <sup>(2)</sup>	ORDERABLE PART NUMBER	TOP-SIDE MARKING
-55°C to 210°C	KGD	INA333SKGD1	NA
	JD	INA333SJD	INA333SJD
	HKJ	INA333SHKJ	INA333SHKJ

- (1) For the most current package and ordering information see the Package Option Addendum at the end of this document, or see the TI web site at [www.ti.com](http://www.ti.com).
- (2) Package drawings, standard packaging quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/packaging](http://www.ti.com/packaging).

### ABSOLUTE MAXIMUM RATINGS<sup>(1)</sup>

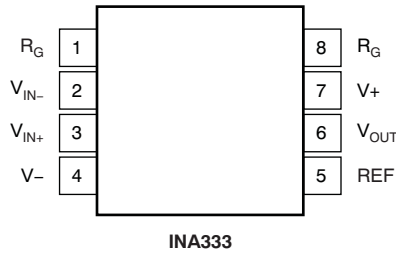
		INA333	UNIT
Supply voltage		+7	V
Analog input voltage range <sup>(2)</sup>		(V-) - 0.3 to (V+) + 0.3	V
Output short-circuit <sup>(3)</sup>		Continuous	
Operating temperature range, T <sub>A</sub>		-55 to +210	°C
Storage temperature range, T <sub>STG</sub>		-65 to +210	°C
Junction temperature, T <sub>J</sub>		+210	°C
ESD rating	Human body model (HBM)	4000	V
	Charged device model (CDM)	1000	V
	Machine model (MM)	200	V

- (1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied.
- (2) Input terminals are diode-clamped to the power-supply rails. Input signals that can swing more than 0.3V beyond the supply rails should be current limited to 10mA or less.
- (3) Short-circuit to ground.

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### PIN CONFIGURATIONS

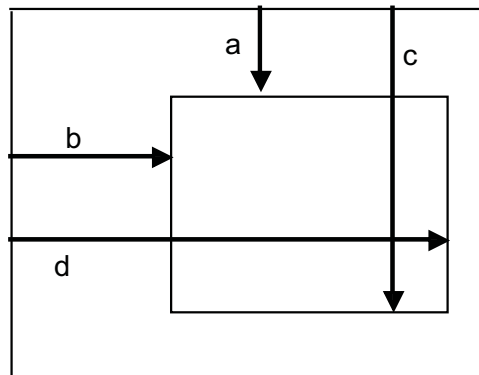
JD OR HKJ PACKAGE  
 MSOP-8  
 (TOP VIEW)



### BARE DIE INFORMATION

DIE THICKNESS	BACKSIDE FINISH	BACKSIDE POTENTIAL	BOND PAD METALLIZATION COMPOSITION
15 mils.	Silicon with backgrind	V-	Al-Si-Cu (0.5%)

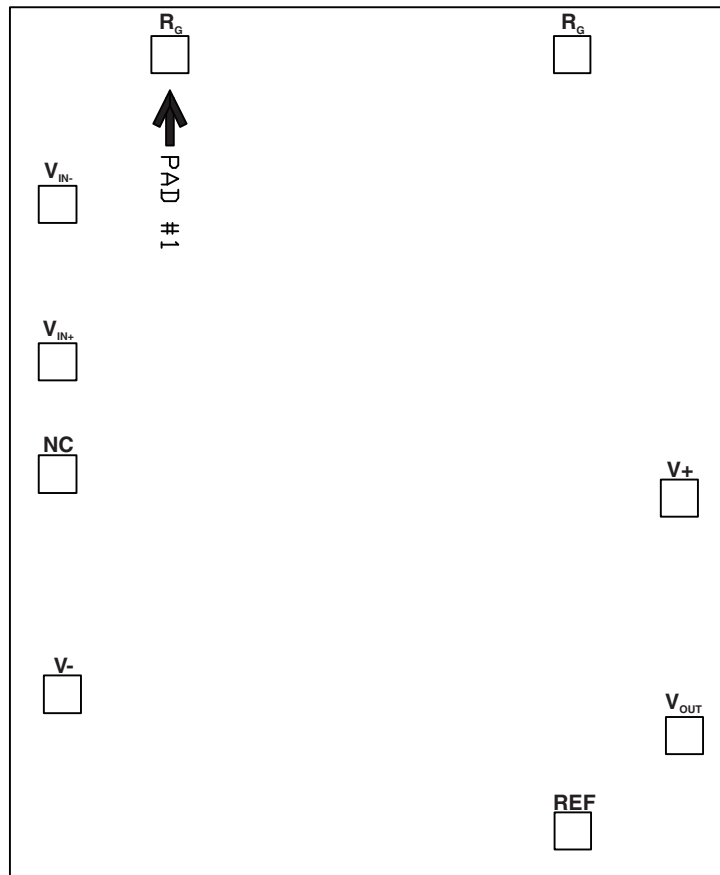
Origin



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**Table 1. Bond Pad Coordinates in Microns**

DISCRIPTION	PAD NUMBER	a	b	c	d
R <sub>G</sub>	1	250	1604.8	326	1680.8
V <sub>IN-</sub>	2	21.2	1300	97.2	1376
V <sub>IN+</sub>	3	21.2	978.5	97.2	1054.5
NC	4	21.2	748.65	97.2	824.65
V <sub>-</sub>	5	31.3	300	107.3	376
REF	6	1072.15	21.2	1148.15	97.2
V <sub>OUT</sub>	7	1299.8	216.2	1375.8	292.2
V <sub>+</sub>	8	1289.7	700	1365.7	776
R <sub>G</sub>	9	1071	1604.8	1147	1680.8



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### THERMAL CHARACTERISTICS FOR JD PACKAGE

over operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
$\theta_{JA}$	Junction-to-ambient thermal resistance <sup>(1)</sup>	High-K board <sup>(2)</sup> , no airflow		64.9		°C/W
		No airflow		83.4		
$\theta_{JB}$	Junction-to-board thermal resistance	High-K board without underfill		27.9		°C/W
$\theta_{JC}$	Junction-to-case thermal resistance			6.49		°C/W

- (1) The intent of  $\theta_{JA}$  specification is solely for a thermal performance comparison of one package to another in a standardized environment. This methodology is not meant to and will not predict the performance of a package in an application-specific environment.  
 (2) JED51-7, high effective thermal conductivity test board for leaded surface mount packages.

### THERMAL CHARACTERISTICS FOR HKJ PACKAGE

over operating free-air temperature range (unless otherwise noted)

PARAMETER		MIN	TYP	MAX	UNIT
$\theta_{JC}$	Junction-to-case thermal resistance (to bottom of case)			5.7	°C/W
	Junction-to-case thermal resistance (to top of case lid - as if formed dead bug)			13.7	

### ELECTRICAL CHARACTERISTICS: $V_S = +1.8\text{ V to }+5.5\text{ V}$

At  $T_A = +25^\circ\text{C}$ ,  $R_L = 10\text{k}\Omega$ ,  $V_{REF} = V_S/2$ , and  $G = 1$ , unless otherwise noted.

PARAMETER	TEST CONDITIONS	$T_A = -55^\circ\text{C to }+125^\circ\text{C}$			$T_A = +210^\circ\text{C}$			UNIT
		MIN	TYP	MAX	MIN	TYP	MAX	
<b>INPUT<sup>(1)</sup></b>								
Offset voltage, $V_{OSI}$ RTI <sup>(2)</sup>			$\pm 10 \pm 25/G$	$\pm 25 \pm 75/G$		$\pm 15$		$\mu\text{V}$
<b>vs Temperature</b>				$\pm 0.1 \pm 0.5/G^{(3)}$		$0.2^{(4)(5)}$		$\mu\text{V}/^\circ\text{C}$
vs Power supply Long-term stability	$1.8\text{ V} \leq V_S \leq 5.5\text{ V}$		$\pm 1 \pm 5/G$	$\pm 5 \pm 15/G$		$2.5^{(4)}$		$\mu\text{V/V}$
Turn-on time to specified $V_{OSI}$		See Typical characteristics			See Typical characteristics			
Impedance								
Differential $Z_{IN}$			$100 \parallel 3$			$100 \parallel 3$		$\text{G}\Omega \parallel \text{pF}$
Common-mode $Z_{IN}$			$100 \parallel 3$			$100 \parallel 3$		$\text{G}\Omega \parallel \text{pF}$
Common-mode voltage range $V_{CM}$	$V_O = 0\text{ V}$	$(V-) + 0.1$		$(V+) - 0.1$	$(V-) + 0.1$		$(V+) - 0.1\text{ V}$	V
Common-mode rejection $\text{CMR}$	DC to 60 Hz							
$G = 1$	$V_{CM} = (V-) + 0.1\text{ V to } (V+) - 0.1\text{ V}$	80	90					dB
$G = 10$	$V_{CM} = (V-) + 0.1\text{ V to } (V+) - 0.1\text{ V}$	100	110					dB
$G = 100$	$V_{CM} = (V-) + 0.1\text{ V to } (V+) - 0.1\text{ V}$	100	115			110		dB
$G = 1000$	$V_{CM} = (V-) + 0.1\text{ V to } (V+) - 0.1\text{ V}$	100	115			113		dB
<b>INPUT BIAS CURRENT</b>								
Input bias current $I_B$			$\pm 70$	$\pm 200$		$\pm 1260$	$\pm 2044$	pA
<b>vs Temperature</b>			See Typical Characteristic curve			See Typical Characteristic curve		$\text{pA}/^\circ\text{C}$
Input offset current $I_{OS}$			$\pm 50$	$\pm 200$				pA
<b>vs Temperature</b>			See Typical Characteristic curve			See Typical Characteristic curve		$\text{pA}/^\circ\text{C}$

- (1) Total  $V_{OS}$ , Referred-to-input =  $(V_{OSI}) + (V_{OSO}/G)$ .  
 (2) RTI = Referred-to-input.  
 (3) Temperature drift is measured from  $-55^\circ\text{C}$  to  $+125^\circ\text{C}$ .  
 (4)  $G = 1000$   
 (5) Temperature drift is measured from  $125^\circ\text{C}$  to  $+210^\circ\text{C}$ .  
 (6) 300-hour life test at  $+150^\circ\text{C}$  demonstrated randomly distributed variation of approximately  $1\ \mu\text{V}$ .

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**ELECTRICAL CHARACTERISTICS:  $V_S = +1.8\text{ V to }+5.5\text{ V}$  (continued)**

 At  $T_A = +25^\circ\text{C}$ ,  $R_L = 10\text{ k}\Omega$ ,  $V_{REF} = V_S/2$ , and  $G = 1$ , unless otherwise noted.

PARAMETER	TEST CONDITIONS	$T_A = -55^\circ\text{C to }+125^\circ\text{C}$			$T_A = +210^\circ\text{C}$			UNIT
		MIN	TYP	MAX	MIN	TYP	MAX	
<b>INPUT VOLTAGE NOISE</b>								
Input voltage noise	$e_{NI}$	$G = 100, R_S = 0\ \Omega$						
$f = 10\text{ Hz}$			42			63		$\text{nV}/\sqrt{\text{Hz}}$
$f = 100\text{ Hz}$			40			70		$\text{nV}/\sqrt{\text{Hz}}$
$f = 1\text{ kHz}$			50			55		$\text{nV}/\sqrt{\text{Hz}}$
$f = 0.1\text{ Hz to }10\text{ Hz}$			2			6		$\mu\text{V}_{PP}$
Input current noise	$i_N$							
$f = 10\text{ Hz}$			100					$\text{fA}/\sqrt{\text{Hz}}$
$f = 0.1\text{ Hz to }10\text{ Hz}$			2					$\text{pA}_{PP}$
<b>GAIN</b>								
Gain equation	$G$		$1 + (100\text{ k}\Omega/R_G)$			$1 + (100\text{ k}\Omega/R_G)$		$\text{V}/\text{V}$
Range of gain <sup>(7)</sup>		1		1000	100		1000	$\text{V}/\text{V}$
Gain error		$V_S = 5.5\text{ V},$ $(V^-) + 100\text{ mV} \leq V_O \leq$ $(V^+) - 100\text{ mV}$						
$G = 1$			$\pm 0.02$	$\pm 0.1$				%
$G = 10$			$\pm 0.05$	$\pm 0.5$				%
$G = 100$			$\pm 0.01$	$\pm 0.5$		$\pm 1.3$		%
$G = 1000$			$\pm 0.43$	$\pm 1.15$		$\pm 1.7$		%
<b>GAIN (continued)</b>								
<b>Gain vs Temperature</b>								
$G = 1$			$\pm 1$	$\pm 5$				$\text{ppm}/^\circ\text{C}$
$G > 1$ <sup>(8)</sup>			$\pm 15$	$\pm 50$				$\text{ppm}/^\circ\text{C}$
Gain nonlinearity		$V_S = 5.5\text{ V},$ $(V^-) + 100\text{ mV} \leq V_O \leq$ $(V^+) - 100\text{ mV}$						
$G = 1\text{ to }1000$		$R_L = 10\text{ k}\Omega$	10			10		ppm
<b>OUTPUT</b>								
Output voltage swing from rail <sup>(9)</sup>		$V_S = 5.5\text{ V}, R_L = 10\text{ k}\Omega$	See note <sup>(9)</sup>	50			185	mV
Capacitive load drive			500			500		pF
Short-circuit current	$I_{SC}$	Continuous to common	-55, +5			-36, +1		mA
<b>FREQUENCY RESPONSE</b>								
Bandwidth, -3dB								
Range of gain <sup>(7)</sup>								
$G = 1$			150					kHz
$G = 10$			35					kHz
$G = 100$			3.5			3.1		kHz
$G = 1000$			350			300		Hz
Slew rate	SR	$V_S = 5\text{ V}, V_O = 4\text{ V Step}$						
$G = 1$			0.16			0.25		$\text{V}/\mu\text{s}$
$G = 100$			0.06			0.04		$\text{V}/\mu\text{s}$
Settling time to 0.01%	$t_S$							
$G = 1$		$V_{STEP} = 4\text{ V}$	35			32		$\mu\text{s}$
$G = 100$		$V_{STEP} = 4\text{ V}$	240			326		$\mu\text{s}$
Settling time to 0.001%	$t_S$							

(7) Not recommend gain &lt; 100 for 210°C application.

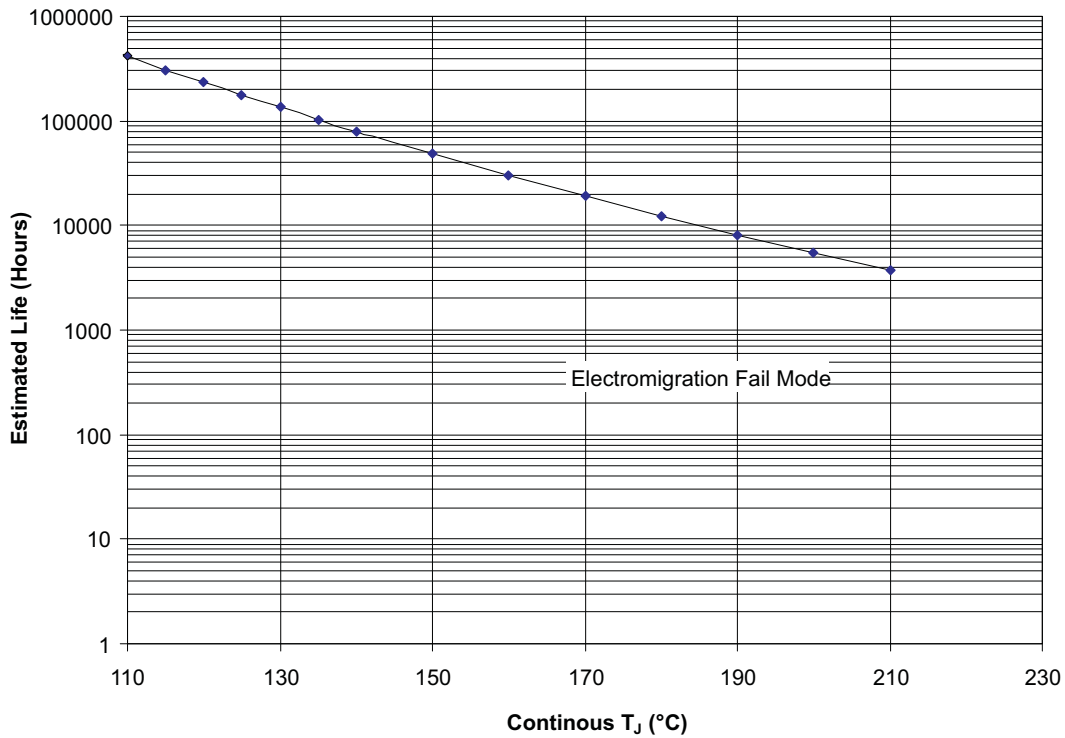
(8) Does not include effects of external resistor  $R_G$ .(9) See Typical Characteristics curve, *Output Voltage Swing vs Output Current* (Figure 31).

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**ELECTRICAL CHARACTERISTICS:  $V_S = +1.8\text{ V to }+5.5\text{ V}$  (continued)**

At  $T_A = +25^\circ\text{C}$ ,  $R_L = 10\text{k}\Omega$ ,  $V_{REF} = V_S/2$ , and  $G = 1$ , unless otherwise noted.

PARAMETER	TEST CONDITIONS	$T_A = -55^\circ\text{C to }+125^\circ\text{C}$			$T_A = +210^\circ\text{C}$			UNIT
		MIN	TYP	MAX	MIN	TYP	MAX	
$G = 1$	$V_{STEP} = 4\text{ V}$		60			55		$\mu\text{s}$
$G = 100$	$V_{STEP} = 4\text{ V}$		500			530		$\mu\text{s}$
Overload recovery	50% overdrive		52			28		$\mu\text{s}$
<b>REFERENCE INPUT</b>								
$R_{IN}$			300			300		$\text{k}\Omega$
Voltage range		V-		V+	V-		V+	V
<b>POWER SUPPLY</b>								
Voltage range								
Single		+1.8		+5.5	+1.8		+5.5	V
Dual		$\pm 0.9$		$\pm 2.75$	$\pm 0.9$		$\pm 2.75$	V
Quiescent current $I_Q$	$V_{IN} = V_S/2$		50	75				$\mu\text{A}$
<b>vs Temperature</b>				<b>80</b>		<b>198</b>	<b>345</b>	$\mu\text{A}$
<b>TEMPERATURE RANGE</b>								
Specified temperature range		-55		+125	-55		+210	$^\circ\text{C}$
Operating temperature range		-55		+125	-55		+210	$^\circ\text{C}$



Notes

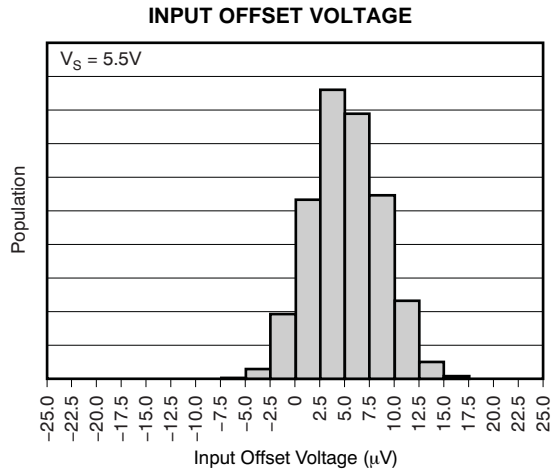
- See datasheet for absolute maximum and minimum recommended operating conditions.
- Silicon operating life design goal is 10 years at  $105^\circ\text{C}$  junction temperature (does not include package interconnect life).

**Figure 1. INA333SKGD1 Operating Life Derating Chart**

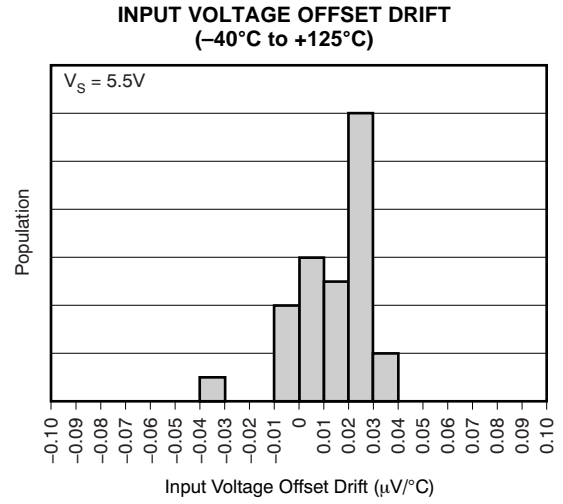
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**TYPICAL CHARACTERISTICS**

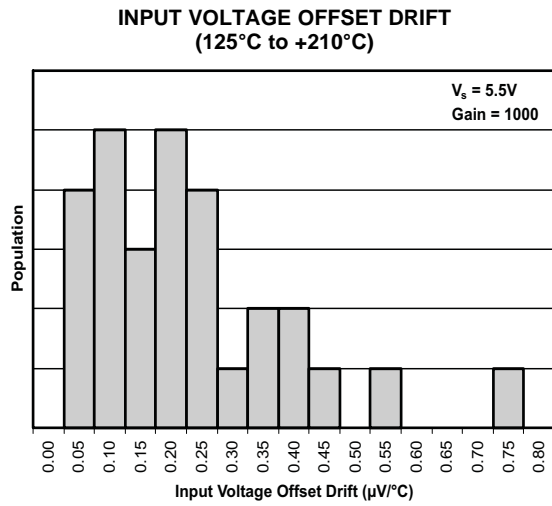
At  $T_A = +25^\circ\text{C}$ ,  $V_S = 5\text{V}$ ,  $R_L = 10\text{k}\Omega$ ,  $V_{REF} = \text{midsupply}$ , and  $G = 1$ , unless otherwise noted.



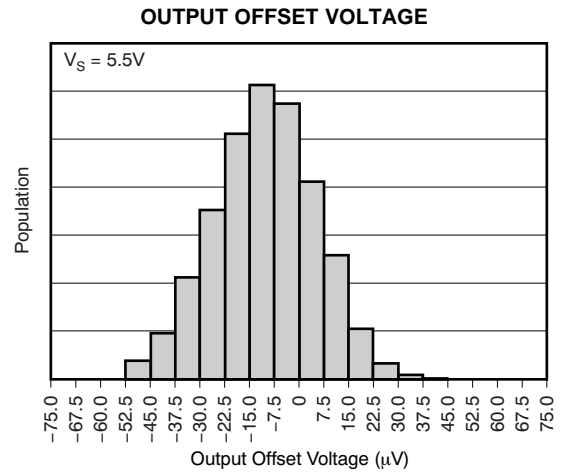
**Figure 2.**



**Figure 3.**



**Figure 4.**



**Figure 5.**



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TYPICAL CHARACTERISTICS (continued)

At  $T_A = +25^\circ\text{C}$ ,  $V_S = 5\text{V}$ ,  $R_L = 10\text{k}\Omega$ ,  $V_{REF} = \text{midsupply}$ , and  $G = 1$ , unless otherwise noted.

OUTPUT VOLTAGE OFFSET DRIFT  
( $-40^\circ\text{C}$  to  $+125^\circ\text{C}$ )

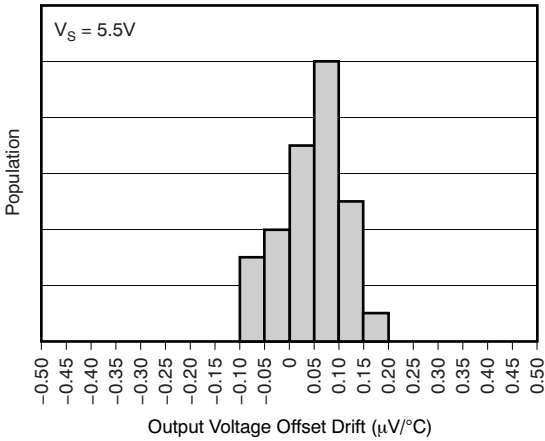


Figure 6.

OFFSET VOLTAGE vs COMMON-MODE VOLTAGE

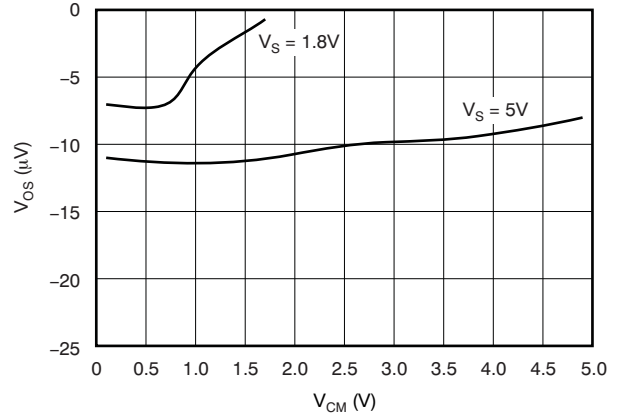


Figure 7.

0.1Hz TO 10Hz NOISE

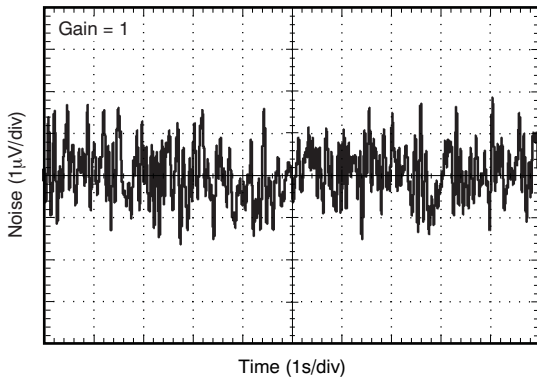


Figure 8.

0.1Hz TO 10Hz NOISE

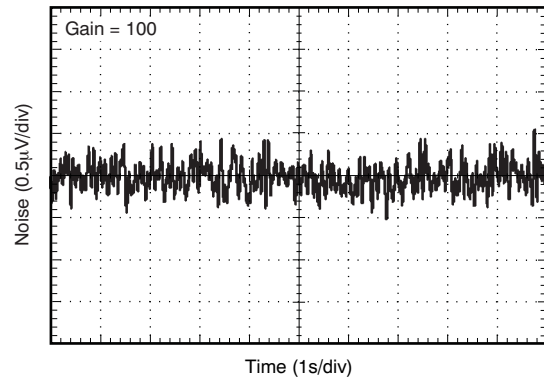


Figure 9.

SPECTRAL NOISE DENSITY

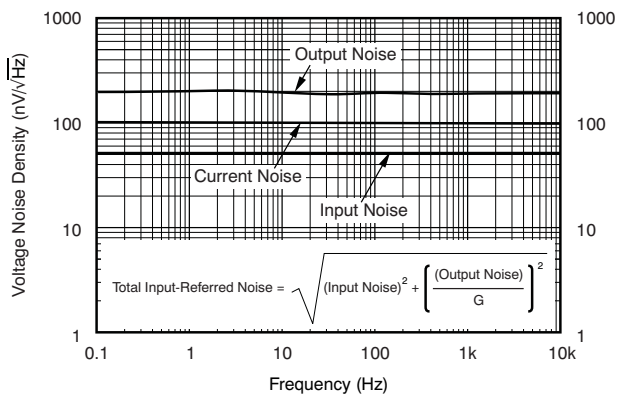


Figure 10.

NONLINEARITY ERROR

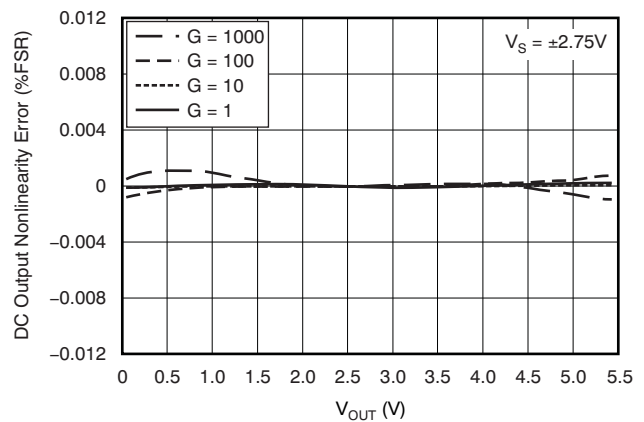


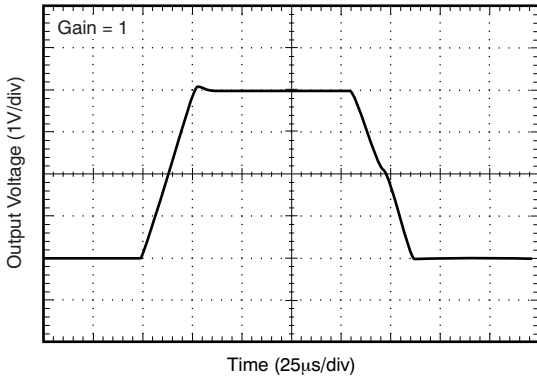
Figure 11.

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**TYPICAL CHARACTERISTICS (continued)**

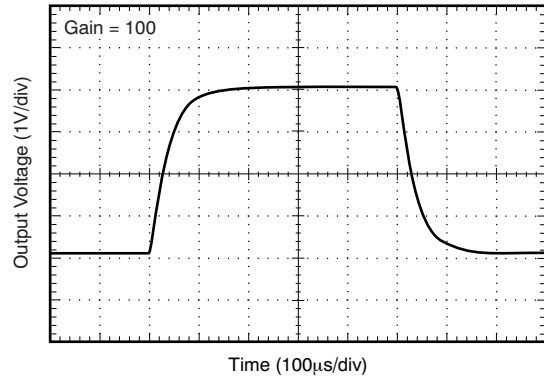
At  $T_A = +25^\circ\text{C}$ ,  $V_S = 5\text{V}$ ,  $R_L = 10\text{k}\Omega$ ,  $V_{REF} = \text{midsupply}$ , and  $G = 1$ , unless otherwise noted.

**LARGE SIGNAL RESPONSE**



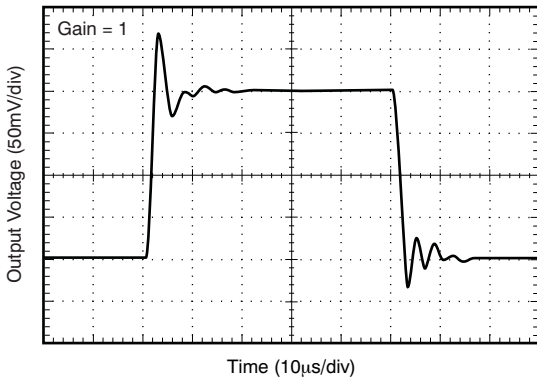
**Figure 12.**

**LARGE-SIGNAL STEP RESPONSE**



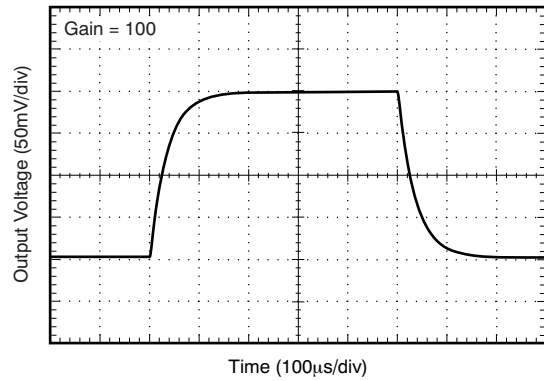
**Figure 13.**

**SMALL-SIGNAL STEP RESPONSE**



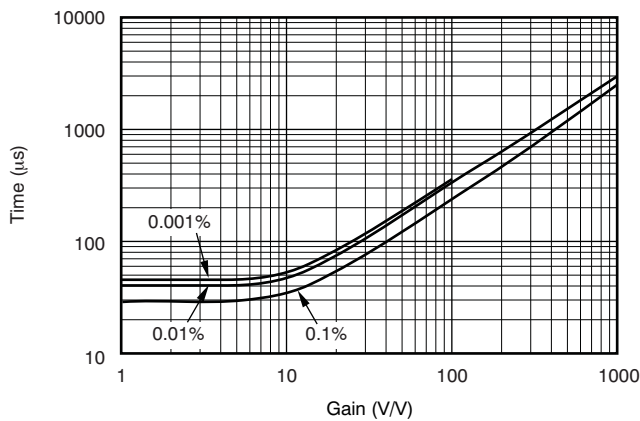
**Figure 14.**

**SMALL-SIGNAL STEP RESPONSE**



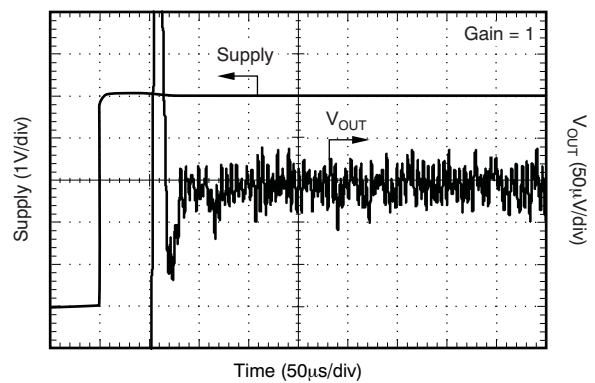
**Figure 15.**

**SETTLING TIME vs GAIN**



**Figure 16.**

**STARTUP SETTLING TIME**



**Figure 17.**

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### TYPICAL CHARACTERISTICS (continued)

At  $T_A = +25^\circ\text{C}$ ,  $V_S = 5\text{V}$ ,  $R_L = 10\text{k}\Omega$ ,  $V_{REF} = \text{midsupply}$ , and  $G = 1$ , unless otherwise noted.

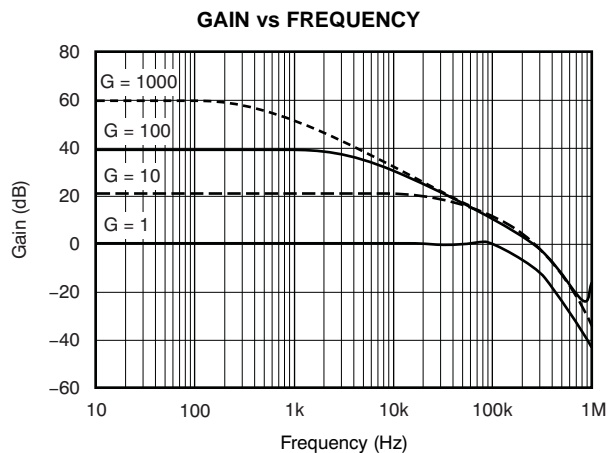


Figure 18.

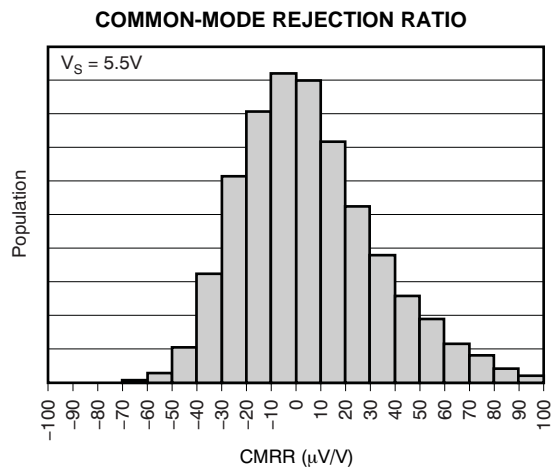


Figure 19.

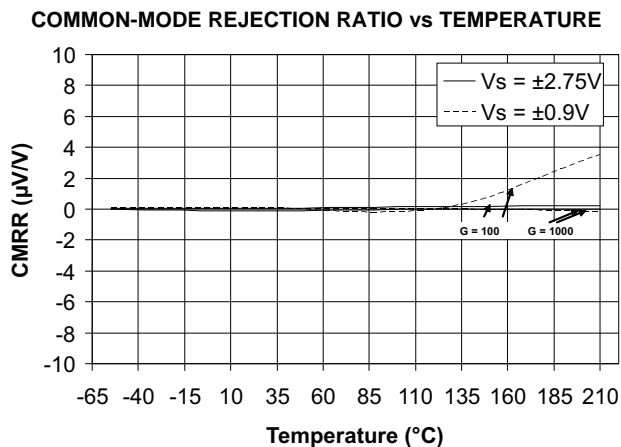


Figure 20.

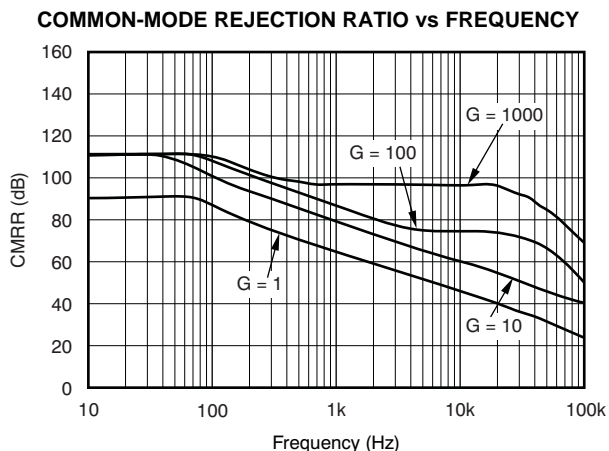


Figure 21.

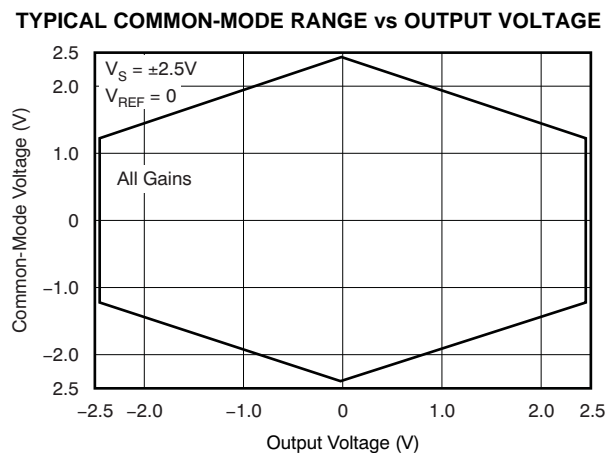


Figure 22.

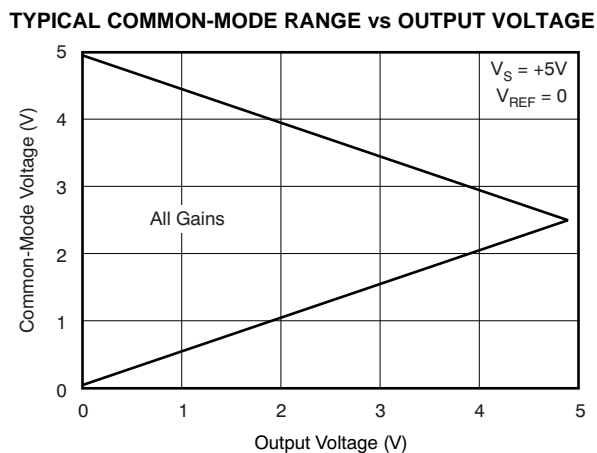


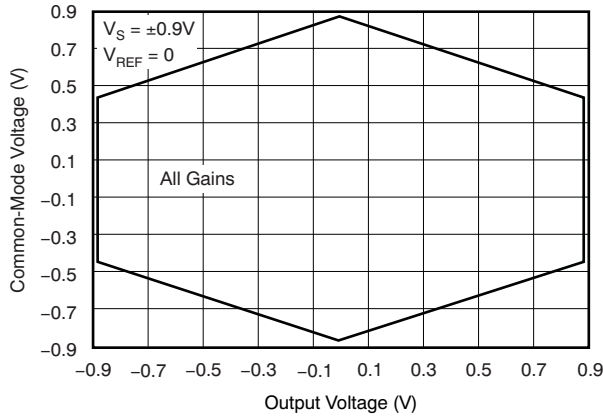
Figure 23.

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**TYPICAL CHARACTERISTICS (continued)**

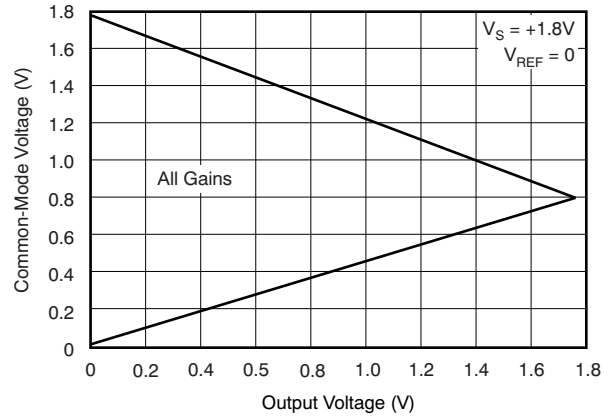
At  $T_A = +25^\circ\text{C}$ ,  $V_S = 5\text{V}$ ,  $R_L = 10\text{k}\Omega$ ,  $V_{REF} = \text{midsupply}$ , and  $G = 1$ , unless otherwise noted.

**TYPICAL COMMON-MODE RANGE vs OUTPUT VOLTAGE**



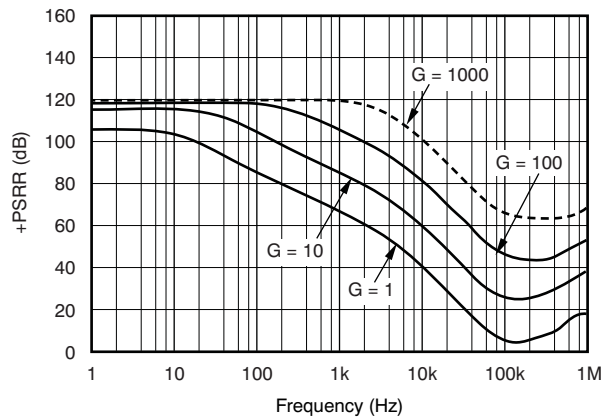
**Figure 24.**

**TYPICAL COMMON-MODE RANGE vs OUTPUT VOLTAGE**



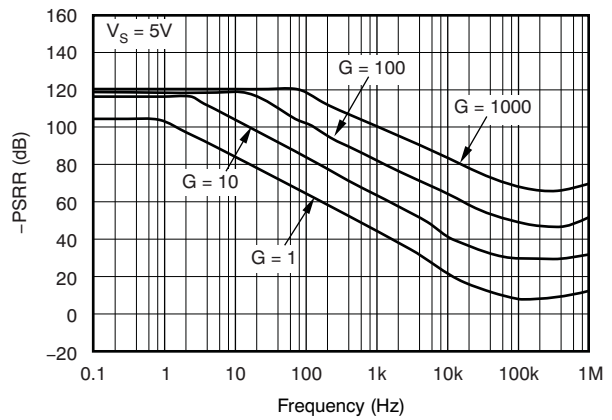
**Figure 25.**

**POSITIVE POWER-SUPPLY REJECTION RATIO**



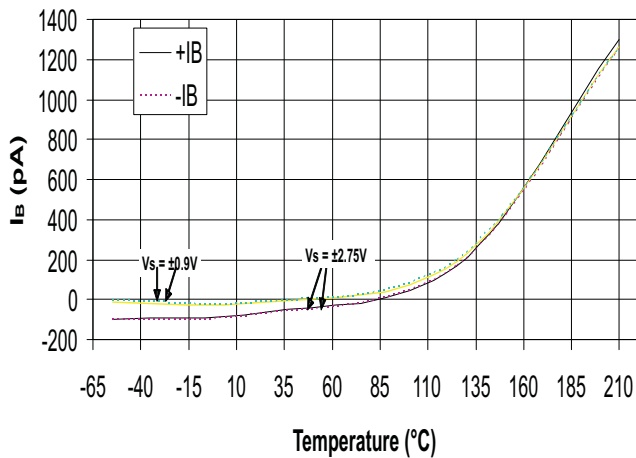
**Figure 26.**

**NEGATIVE POWER-SUPPLY REJECTION RATIO**



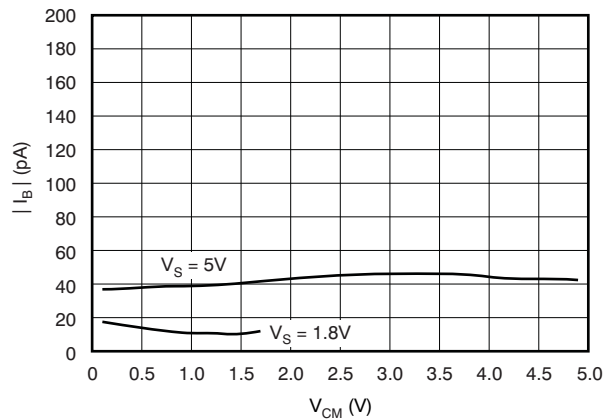
**Figure 27.**

**INPUT BIAS CURRENT vs TEMPERATURE**



**Figure 28.**

**| INPUT BIAS CURRENT | vs COMMON-MODE VOLTAGE**



**Figure 29.**

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**TYPICAL CHARACTERISTICS (continued)**

At  $T_A = +25^\circ\text{C}$ ,  $V_S = 5\text{V}$ ,  $R_L = 10\text{k}\Omega$ ,  $V_{\text{REF}} = \text{midsupply}$ , and  $G = 1$ , unless otherwise noted.

**INPUT OFFSET CURRENT vs TEMPERATURE**

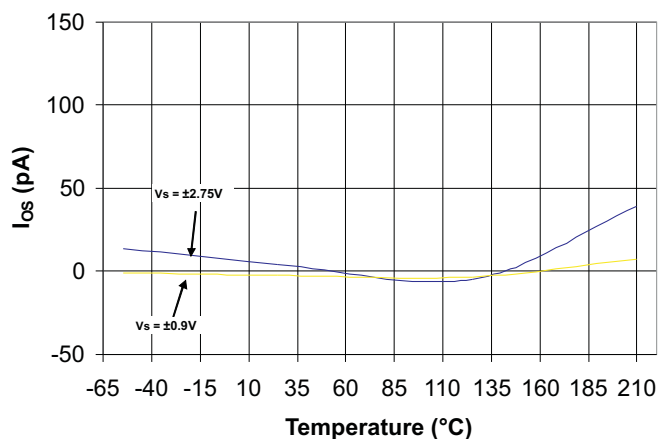


Figure 30.

**OUTPUT VOLTAGE SWING vs OUTPUT CURRENT**

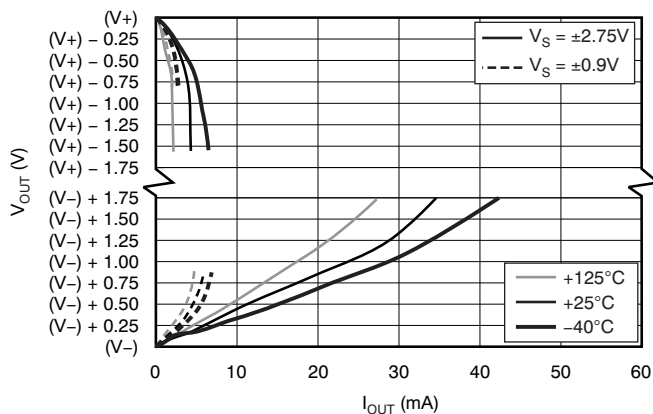


Figure 31.

**QUIESCENT CURRENT vs TEMPERATURE**

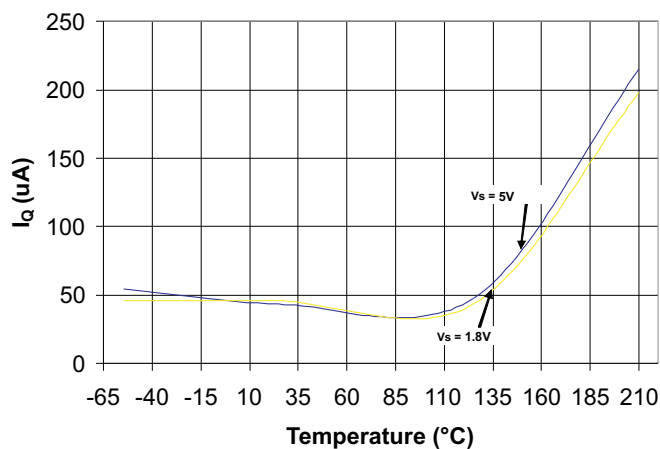


Figure 32.

**QUIESCENT CURRENT vs COMMON-MODE VOLTAGE**

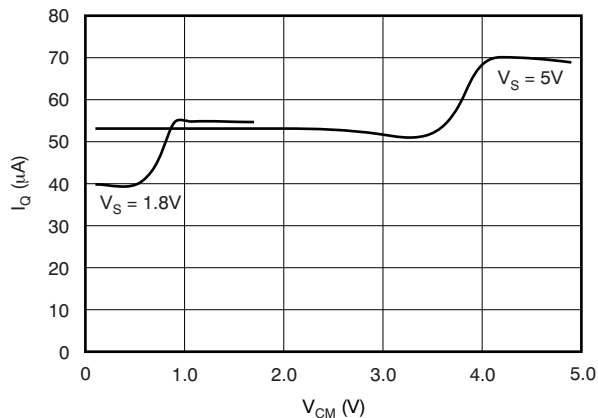


Figure 33.

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## APPLICATION INFORMATION

Application information below is provided for commercial temperature as a reference and not for high temperature.

It is not recommended to use gain < 100 for the high temperature (210°C) application. A filter is needed between Pin 1 and Pin 9 for gain = 100 and gain = 1000 in 210°C application. Recommended resistor value is 3.5 kΩ and capacitor value is 10 nF.

[Figure 34](#) shows the basic connections required for operation of the INA333. Good layout practice mandates the use of bypass capacitors placed close to the device pins as shown.

The output of the INA333 is referred to the output reference (REF) terminal, which is normally grounded. This connection must be low-impedance to assure good common-mode rejection. Although 15 Ω or less of stray resistance can be tolerated while maintaining specified CMRR, small stray resistances of tens of ohms in series with the REF pin can cause noticeable degradation in CMRR.

### SETTING THE GAIN

Gain of the INA333 is set by a single external resistor,  $R_G$ , connected between pins 1 and 8. The value of  $R_G$  is selected according to [Equation 1](#):

$$G = 1 + (100 \text{ k}\Omega/R_G) \quad (1) \quad (1)$$

[Table 2](#) lists several commonly-used gains and resistor values. The 100 kΩ term in [Equation 1](#) comes from the sum of the two internal feedback resistors of  $A_1$  and  $A_2$ . These on-chip resistors are laser trimmed to accurate absolute values. The accuracy and temperature coefficient of these resistors are included in the gain accuracy and drift specifications of the INA333.

The stability and temperature drift of the external gain setting resistor,  $R_G$ , also affects gain. The contribution of  $R_G$  to gain accuracy and drift can be directly inferred from the gain [Equation 1](#). Low resistor values required for high gain can make wiring resistance important. Sockets add to the wiring resistance and contribute additional gain error (possibly an unstable gain error) in gains of approximately 100 or greater. To ensure stability, avoid parasitic capacitance of more than a few picofarads at the  $R_G$  connections. Careful matching of any parasitics on both  $R_G$  pins maintains optimal CMRR over frequency.

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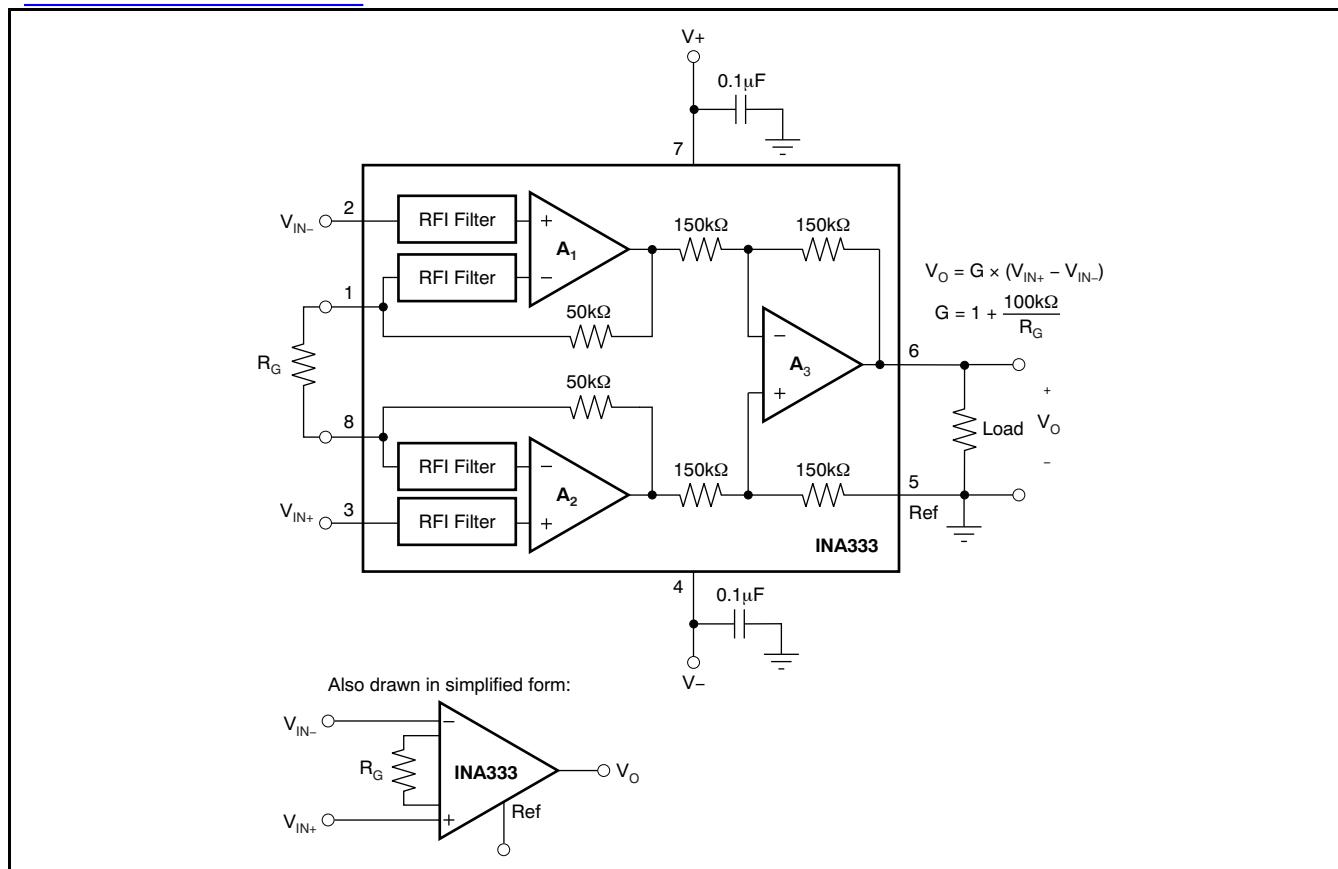


Figure 34. Basic Connections

Table 2. Commonly-Used Gains and Resistor Values

DESIRED GAIN	R <sub>G</sub> (Ω)	NEAREST 1% R <sub>G</sub> (Ω)
1	NC <sup>(1)</sup>	NC
2	100k	100k
5	25k	24.9k
10	11.1k	11k
20	5.26k	5.23k
50	2.04k	2.05
100	1.01k	1k
200	502.5	499
500	200.4	200
1000	100.1	100

(1) NC denotes no connection. When using the SPICE model, the simulation will not converge unless a resistor is connected to the R<sub>G</sub> pins; use a very large resistor value.

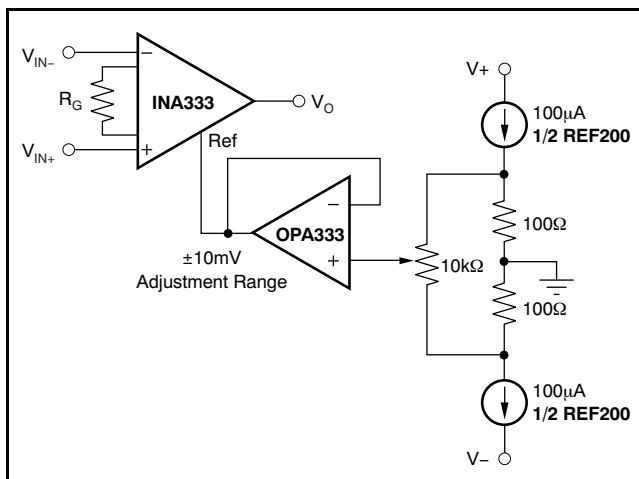
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### INTERNAL OFFSET CORRECTION

The INA333 internal op amps use an auto-calibration technique with a time-continuous 350-kHz op amp in the signal path. The amplifier is zero-corrected every 8  $\mu$ s using a proprietary technique. Upon power-up, the amplifier requires approximately 100  $\mu$ s to achieve specified  $V_{OS}$  accuracy. This design has no aliasing or flicker noise.

### OFFSET TRIMMING

Most applications require no external offset adjustment; however, if necessary, adjustments can be made by applying a voltage to the REF terminal. [Figure 35](#) shows an optional circuit for trimming the output offset voltage. The voltage applied to REF terminal is summed at the output. The op amp buffer provides low impedance at the REF terminal to preserve good common-mode rejection.



**Figure 35. Optional Trimming of Output Offset Voltage**

### NOISE PERFORMANCE

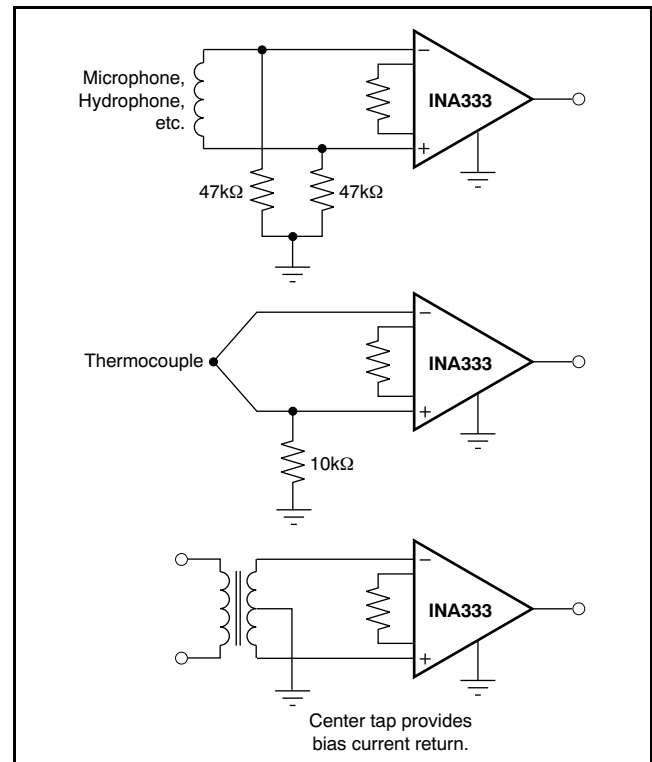
The auto-calibration technique used by the INA333 results in reduced low frequency noise, typically only 50 nV/ $\sqrt{\text{Hz}}$ , ( $G = 100$ ). The spectral noise density can be seen in detail in [Figure 10](#). Low frequency noise of the INA333 is approximately 1  $\mu$ V<sub>PP</sub> measured from 0.1 Hz to 10 Hz, ( $G = 100$ ).

### INPUT BIAS CURRENT RETURN PATH

The input impedance of the INA333 is extremely high—approximately 100 G $\Omega$ . However, a path must be provided for the input bias current of both inputs. This input bias current is typically  $\pm 70$  pA. High input impedance means that this input bias current changes very little with varying input voltage.

Input circuitry must provide a path for this input bias current for proper operation. [Figure 36](#) illustrates various provisions for an input bias current path.

Without a bias current path, the inputs will float to a potential that exceeds the common-mode range of the INA333, and the input amplifiers will saturate. If the differential source resistance is low, the bias current return path can be connected to one input (see the thermocouple example in [Figure 36](#)). With higher source impedance, using two equal resistors provides a balanced input with possible advantages of lower input offset voltage as a result of bias current and better high-frequency common-mode rejection.



**Figure 36. Providing an Input Common-Mode Current Path**

### INPUT COMMON-MODE RANGE

The linear input voltage range of the input circuitry of the INA333 is from approximately 0.1 V below the positive supply voltage to 0.1 V above the negative supply. As a differential input voltage causes the output voltage to increase, however, the linear input range is limited by the output voltage swing of amplifiers  $A_1$  and  $A_2$ . Thus, the linear common-mode input range is related to the output voltage of the complete amplifier. This behavior also depends on supply voltage—see Typical Characteristic curves *Typical Common-Mode Range vs Output Voltage* ([Figure 22](#) to [Figure 25](#)).

Input overload conditions can produce an output voltage that appears normal. For example, if an input



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overload condition drives both input amplifiers to the respective positive output swing limit, the difference voltage measured by the output amplifier is near zero. The output of the INA333 is near 0 V even though both inputs are overloaded.

### OPERATING VOLTAGE

The INA333 operates over a power-supply range of +1.8 V to +5.5 V ( $\pm 0.9$  V to  $\pm 2.75$  V). Supply voltages higher than +7 V (absolute maximum) can permanently damage the device. Parameters that vary over supply voltage or temperature are shown in the [Typical Characteristics](#) section of this data sheet.

### LOW VOLTAGE OPERATION

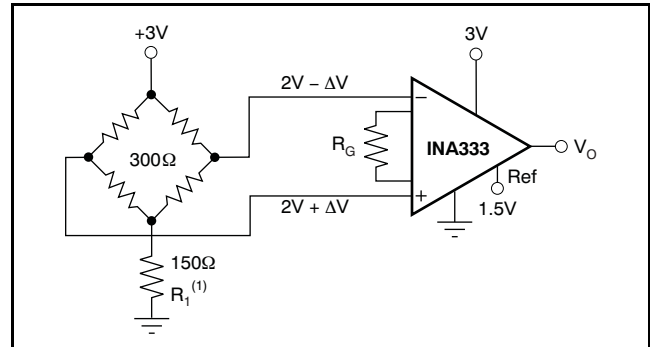
The INA333 can be operated on power supplies as low as  $\pm 0.9$  V. Most parameters vary only slightly throughout this supply voltage range—see the [Typical Characteristics](#) section. Operation at very low supply voltage requires careful attention to assure that the input voltages remain within the linear range. Voltage swing requirements of internal nodes limit the input common-mode range with low power-supply voltage. The Typical Characteristic curves *Typical Common-Mode Range vs Output Voltage* (Figure 22 to Figure 25) show the range of linear operation for various supply voltages and gains.

### SINGLE-SUPPLY OPERATION

The INA333 can be used on single power supplies of +1.8 V to +5.5 V. Figure 37 illustrates a basic single-supply circuit. The output REF terminal is connected to mid-supply. Zero differential input voltage demands an output voltage of mid-supply. Actual output voltage swing is limited to approximately 50 mV above ground, when the load is referred to ground as shown. The typical characteristic curve *Output Voltage Swing vs Output Current* (Figure 31) shows how the output voltage swing varies with output current.

With single-supply operation,  $V_{IN+}$  and  $V_{IN-}$  must both be 0.1V above ground for linear operation. For instance, the inverting input cannot be connected to ground to measure a voltage connected to the noninverting input.

To illustrate the issues affecting low voltage operation, consider the circuit in Figure 37. It shows the INA333 operating from a single 3-V supply. A resistor in series with the low side of the bridge assures that the bridge output voltage is within the common-mode range of the amplifier inputs.



(1)  $R_1$  creates proper common-mode voltage, only for low-voltage operation—see the [Single-Supply Operation](#) section.

**Figure 37. Single-Supply Bridge Amplifier**

### INPUT PROTECTION

The input terminals of the INA333 are protected with internal diodes connected to the power-supply rails. These diodes clamp the applied signal to prevent it from damaging the input circuitry. If the input signal voltage can exceed the power supplies by more than 0.3 V, the input signal current should be limited to less than 10 mA to protect the internal clamp diodes. This current limiting can generally be done with a series input resistor. Some signal sources are inherently current-limited and do not require limiting resistors.

### GENERAL LAYOUT GUIDELINES

Attention to good layout practices is always recommended. Keep traces short and, when possible, use a printed circuit board (PCB) ground plane with surface-mount components placed as close to the device pins as possible. Place a 0.1- $\mu$ F bypass capacitor closely across the supply pins. These guidelines should be applied throughout the analog circuit to improve performance and provide benefits such as reducing the electromagnetic-interference (EMI) susceptibility.

Instrumentation amplifiers vary in the susceptibility to radio-frequency interference (RFI). RFI can generally be identified as a variation in offset voltage or dc signal levels with changes in the interfering RF signal. The INA333 has been specifically designed to minimize susceptibility to RFI by incorporating passive RC filters with an 8-MHz corner frequency at the  $V_{IN+}$  and  $V_{IN-}$  inputs. As a result, the INA333 demonstrates remarkably low sensitivity compared to previous generation devices. Strong RF fields may continue to cause varying offset levels, however, and may require additional shielding.

### APPLICATION IDEAS

Additional application ideas are shown in [Figure 38](#) to [Figure 41](#).

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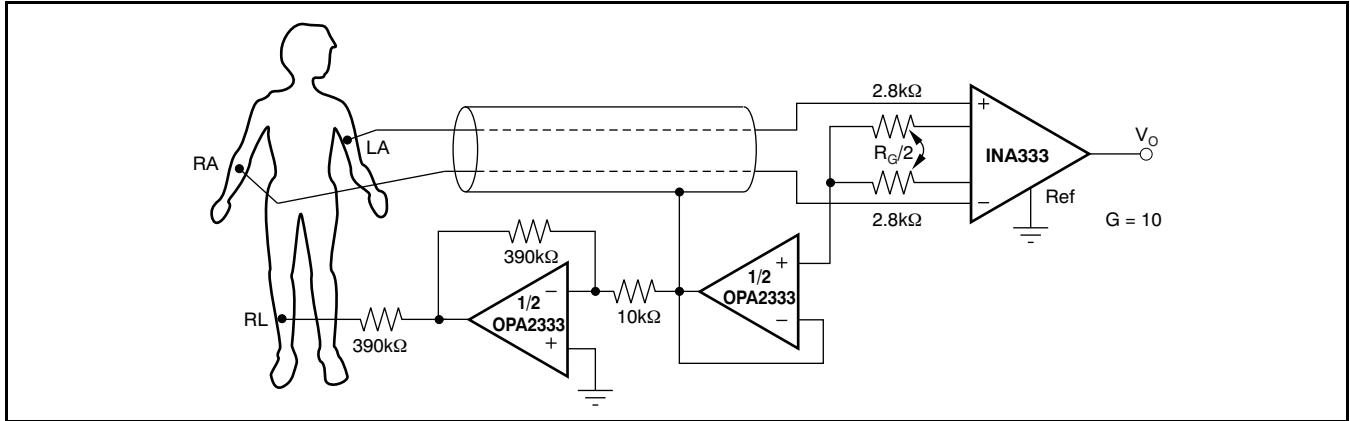


Figure 38. ECG Amplifier With Right-Leg Drive

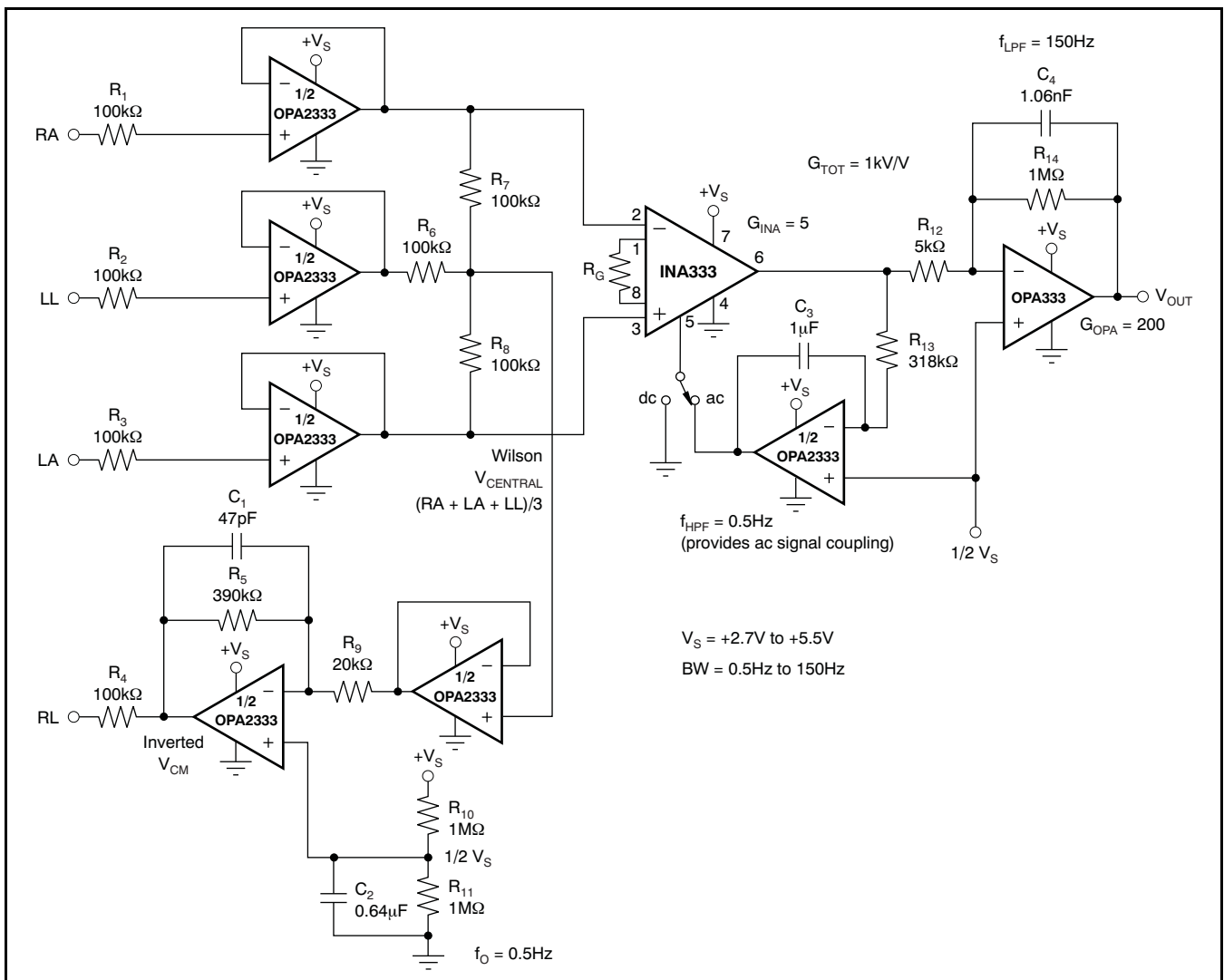


Figure 39. Single-Supply, Very Low Power, ECG Circuit

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**TINA-TI  
(FREE DOWNLOAD SOFTWARE)**

**Using TINA-TI SPICE-Based Analog Simulation Program with the INA333**

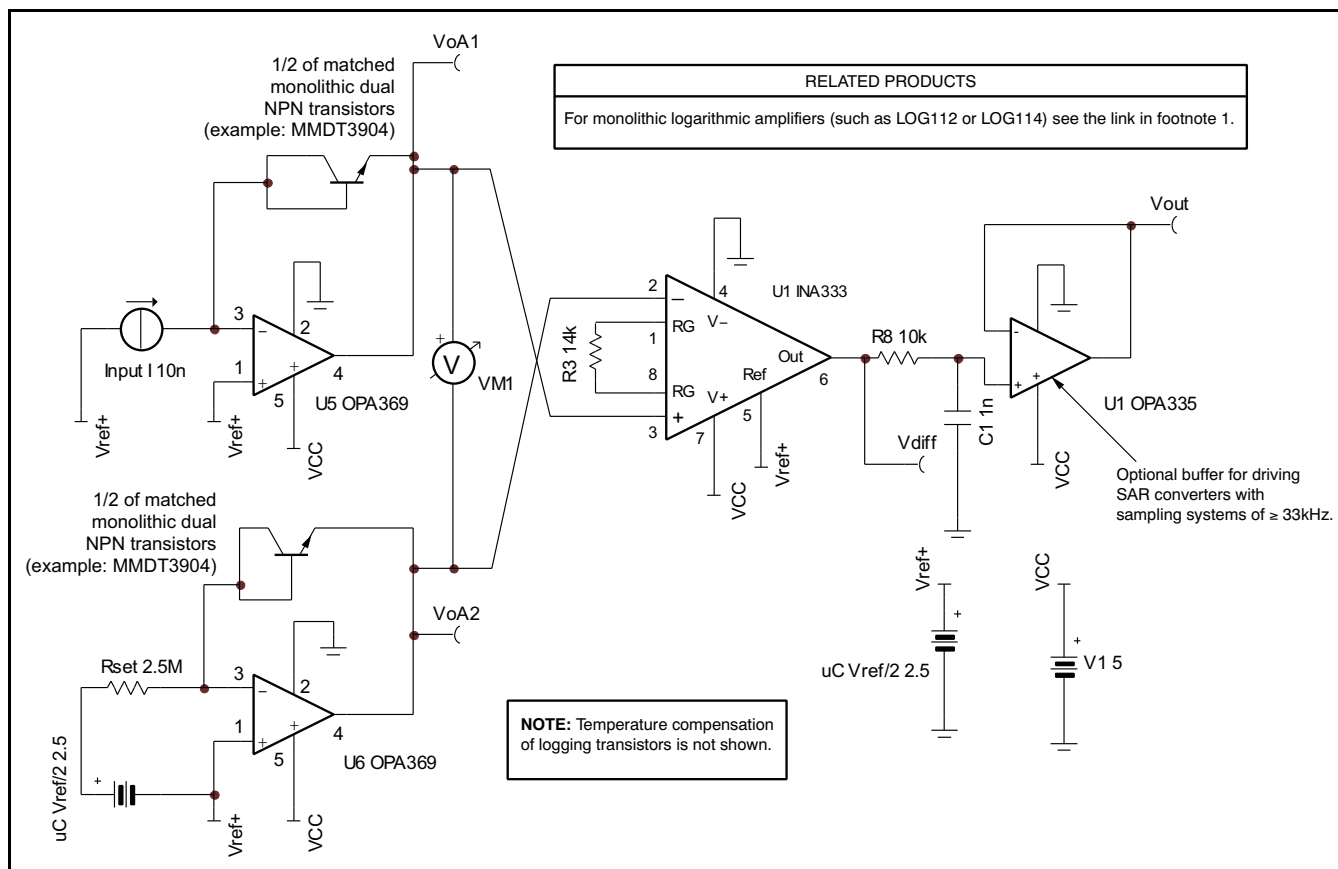
TINA is a simple, powerful, and easy-to-use circuit simulation program based on a SPICE engine. TINA-TI is a free, fully functional version of the TINA software, preloaded with a library of macromodels in addition to a range of both passive and active models. It provides all the conventional dc, transient, and frequency domain analysis of SPICE as well as additional design capabilities.

Available as a free download from the [Analog eLab Design Center](#), TINA-TI offers extensive post-processing capability that allows users to format results in a variety of ways.

Virtual instruments offer users the ability to select input waveforms and probe circuit nodes, voltages, and waveforms, creating a dynamic quick-start tool.

Figure 40 and Figure 41 show example TINA-TI circuits for the INA333 that can be used to develop, modify, and assess the circuit design for specific applications. Links to download these simulation files are given below.

**NOTE:** these files require that either the TINA software (from DesignSoft) or TINA-TI software be installed. Download the free TINA-TI software from the [TINA-TI folder](#).



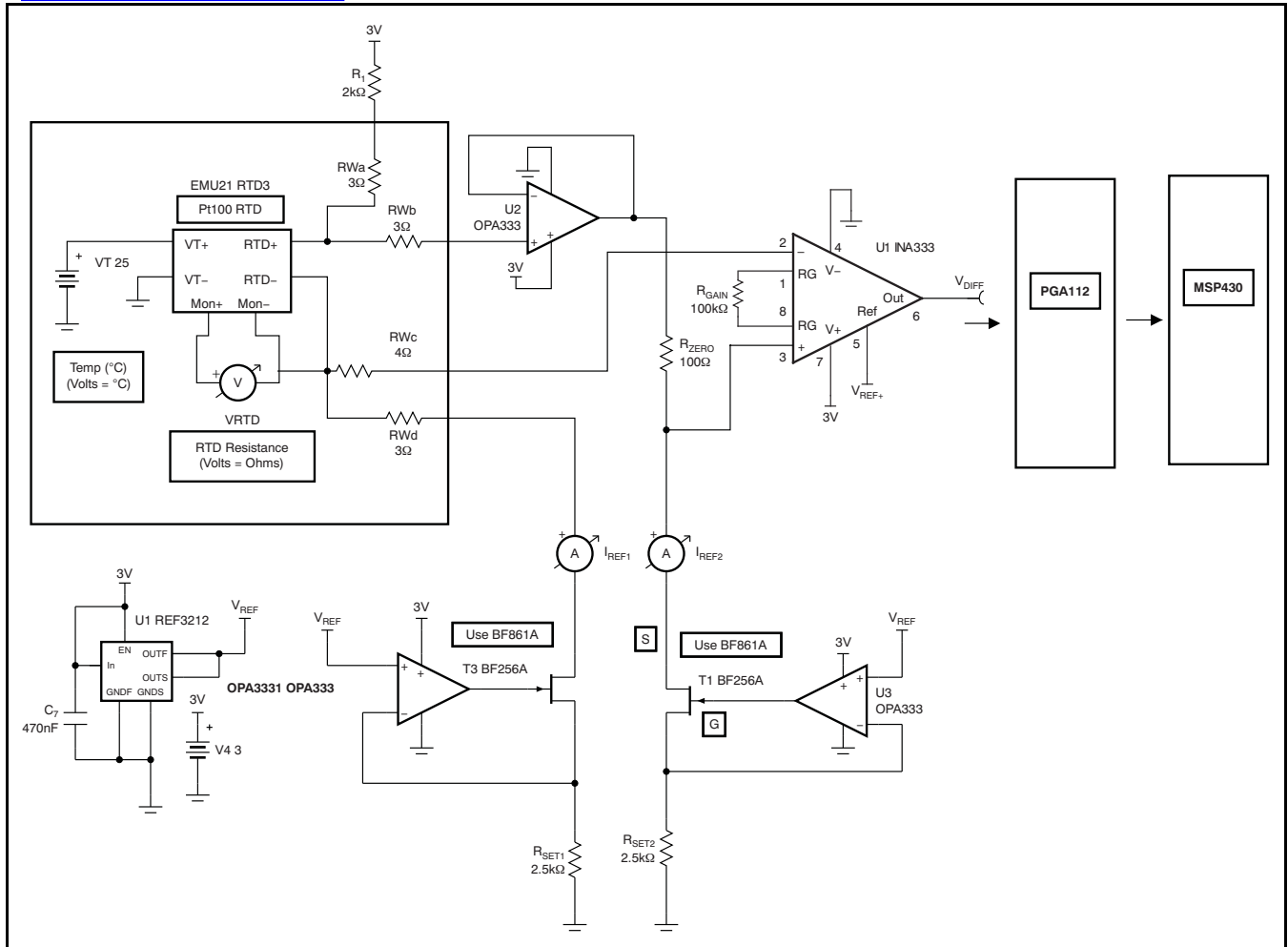
**RELATED PRODUCTS**  
For monolithic logarithmic amplifiers (such as LOG112 or LOG114) see the link in footnote 1.

(1) The following link launches the TI logarithmic amplifiers web page: [Logarithmic Amplifier Products Home Page](#)

**Figure 40. Low-Power Log Function Circuit for Portable Battery-Powered Systems (Example Glucose Meter)**

To download a compressed file that contains the TINA-TI simulation file for this circuit, click the following link: [Log Circuit](#).

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RWa, RWb, RWc, and RWd simulate wire resistance. These resistors are included to show the four-wire sense technique immunity to line mismatches. This method assumes the use of a four-wire RTD.

**Figure 41. Four-Wire, 3V Conditioner for a PT100 RTD With Programmable Gain Acquisition System**

To download a compressed file that contains the TINA-TI simulation file for this circuit, click the following link: [PT100 RTD](#).



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PACKAG

## PACKAGING INFORMATION

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak
INA333SHKJ	ACTIVE	CFP	HKJ	8	25	TBD	Call TI	N / A for Pkg
INA333SJD	ACTIVE	CDIP SB	JD	8	45	TBD	POST-PLATE	N / A for Pkg
INA333SKGD1	ACTIVE	XCEPT	KGD	0	240	TBD	Call TI	N / A for Pkg

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBsolete:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com> for more information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for high temperature applications.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based leadframe materials used in the leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (both in homogeneous material).

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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### OTHER QUALIFIED VERSIONS OF INA333-HT :

- Catalog: [INA333](#)

NOTE: Qualified Version Definitions:

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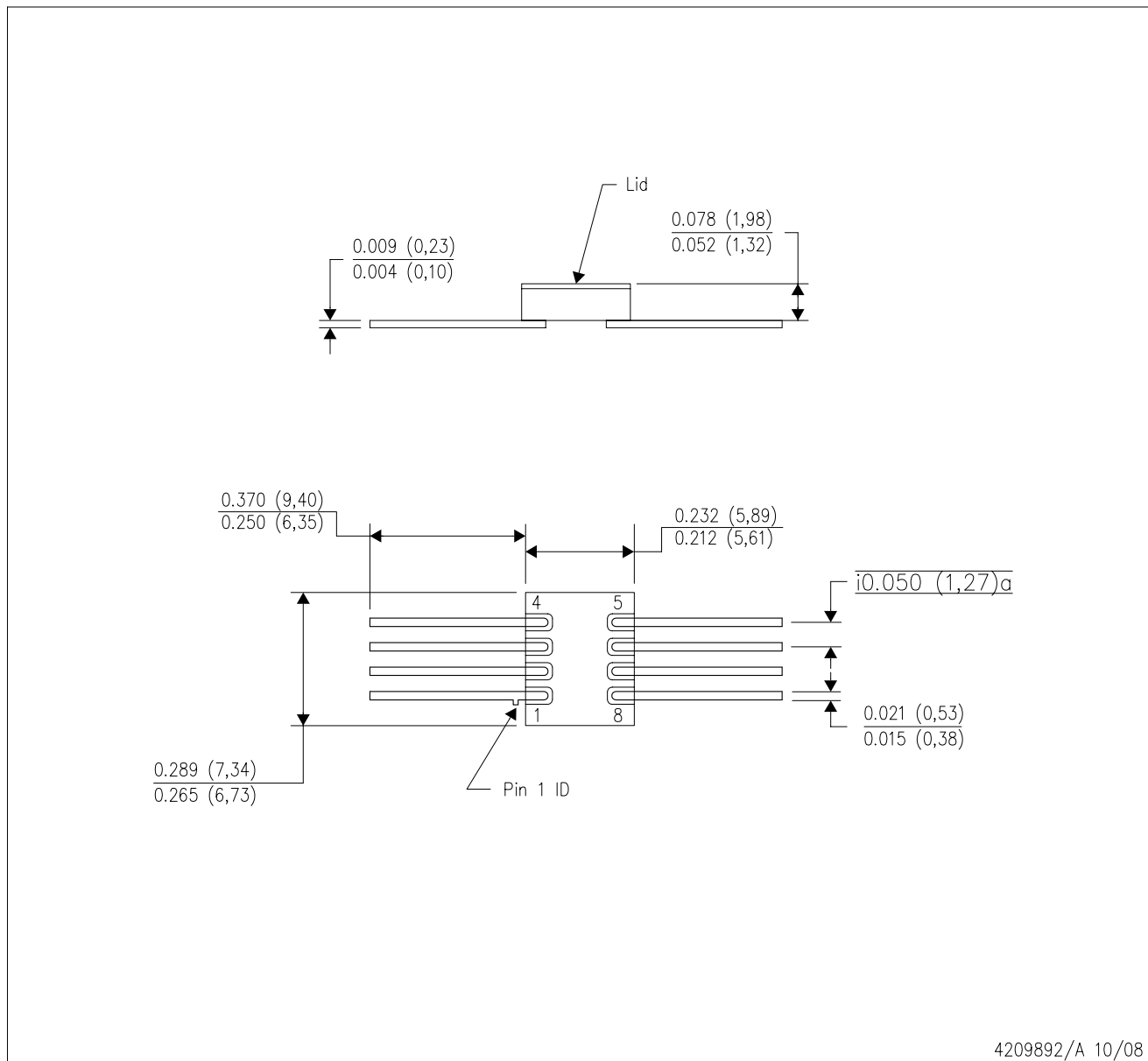


PACKAG

- 
- Catalog - TI's standard catalog product

HKJ (R-CDFP-F8)

CERAMIC DUAL FLATPACK



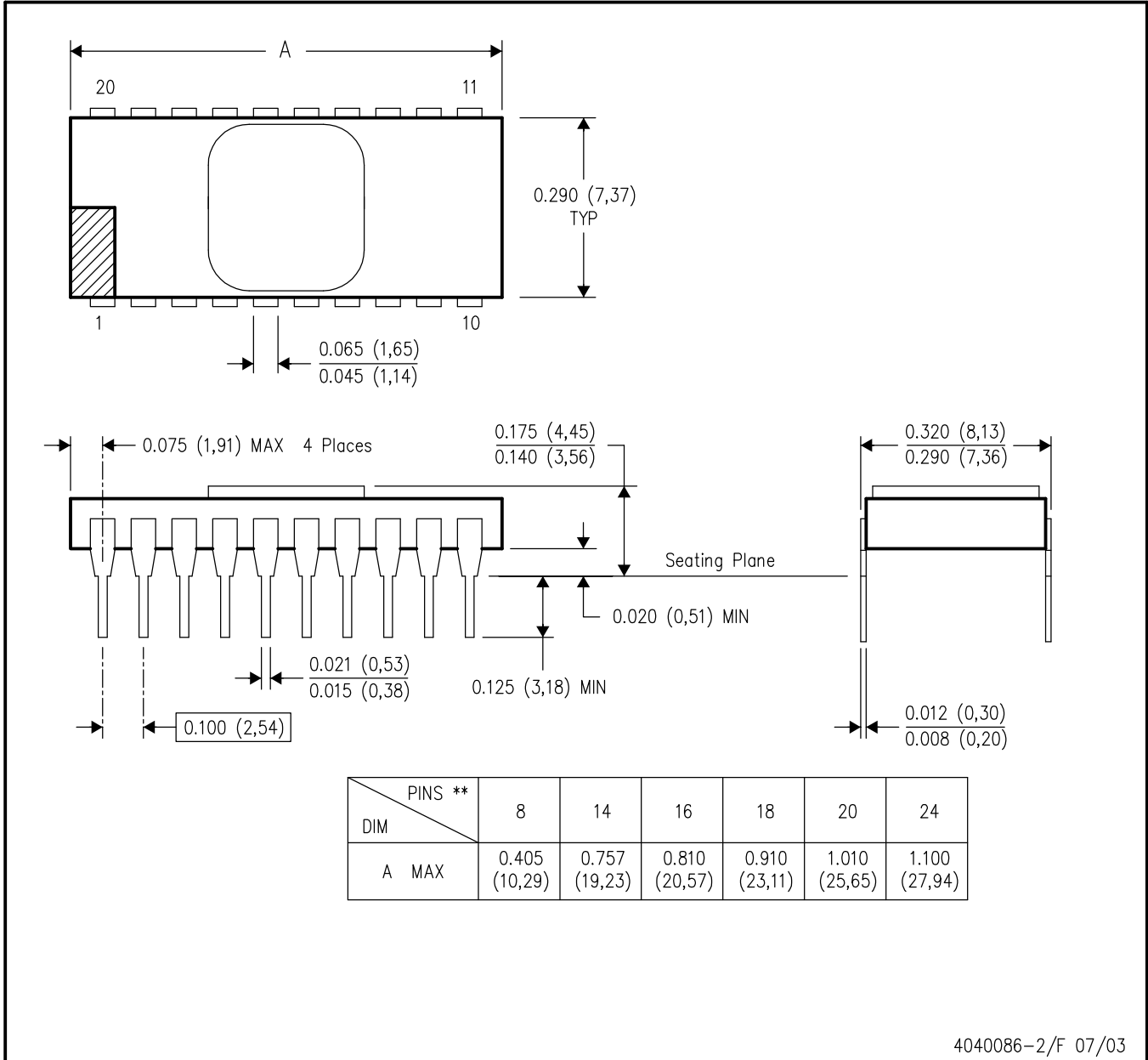
- NOTES:
- All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice.
  - This package can be hermetically sealed with a metal lid.
  - The terminals will be gold plated.

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JD (R-CDIP-T\*\*)

CERAMIC SIDE-BRAZE DUAL-IN-LINE PACKAGE

20 PINS SHOWN



4040086-2/F 07/03

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package is hermetically sealed with a metal lid.
  - D. The terminals are gold plated.
  - E. Falls within MIL STD 1835 CDIP2 - T8, T14, T16, T18, T20 and T24 respectively.



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Data Converters	<a href="http://dataconverter.ti.com">dataconverter.ti.com</a>	Automotive	<a href="http://www.ti.com/automotive">www.ti.com/automotive</a>
DLP® Products	<a href="http://www.dlp.com">www.dlp.com</a>	Communications and Telecom	<a href="http://www.ti.com/communications">www.ti.com/communications</a>
DSP	<a href="http://dsp.ti.com">dsp.ti.com</a>	Computers and Peripherals	<a href="http://www.ti.com/computers">www.ti.com/computers</a>
Clocks and Timers	<a href="http://www.ti.com/clocks">www.ti.com/clocks</a>	Consumer Electronics	<a href="http://www.ti.com/consumer-apps">www.ti.com/consumer-apps</a>
Interface	<a href="http://interface.ti.com">interface.ti.com</a>	Energy	<a href="http://www.ti.com/energy">www.ti.com/energy</a>
Logic	<a href="http://logic.ti.com">logic.ti.com</a>	Industrial	<a href="http://www.ti.com/industrial">www.ti.com/industrial</a>
Power Mgmt	<a href="http://power.ti.com">power.ti.com</a>	Medical	<a href="http://www.ti.com/medical">www.ti.com/medical</a>
Microcontrollers	<a href="http://microcontroller.ti.com">microcontroller.ti.com</a>	Security	<a href="http://www.ti.com/security">www.ti.com/security</a>
RFID	<a href="http://www.ti-rfid.com">www.ti-rfid.com</a>	Space, Avionics & Defense	<a href="http://www.ti.com/space-avionics-defense">www.ti.com/space-avionics-defense</a>
RF/IF and ZigBee® Solutions	<a href="http://www.ti.com/lprf">www.ti.com/lprf</a>	Video and Imaging	<a href="http://www.ti.com/video">www.ti.com/video</a>
		Wireless	<a href="http://www.ti.com/wireless-apps">www.ti.com/wireless-apps</a>